3.3V LVTTL/LVCMOS to LVPECL Translator

Description

The MC100EPT622 is a 10–Bit LVTTL/LVCMOS to LVPECL translator. Because LVPECL (Positive ECL) levels are used only +3.3 V and ground are required. The device has an OR–ed enable input which can accept either LVPECL (ENPECL) or TTL/LVCMOS inputs (ENTTL). If the inputs are left open, they will default to the enable state. The device design has been optimized for low channel–to–channel skew.

Features

- 450 ps Typical Propagation Delay
- Maximum Frequency > 1.5 GHz Typical
- PECL Mode
- Operating Range: $V_{CC} = 3.0 \text{ V}$ to 3.8 V with $V_{EE} = 0 \text{ V}$
- PNP LVTTL Inputs for Minimal Loading
- Q Output Will Default HIGH with Inputs Open
- The 100 Series Contains Temperature Compensation
- Pb-Free Packages are Available*



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*For additional marking information, refer to Application Note AND8002/D.

Table 1. TRUTH TABLE

ENPECL	ENTTL	D	Q
н	х	н	Н
н	х	L	L
х	Н	Н	Н
х	н	L	L
L	L	х	L

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



Table 1. PIN DESCRIPTION

Pin	Function
D0:9	Data Input (TTL)
Q0:9	Data Outputs (PECL)
ENTTL	Enable Control (TTL)
ENPECL	Enable Control (PECL)
V _{CC} , V _{CCO}	Positive Supply
V _{EE}	Ground
EP	The exposed pad (EP) on the QFN–32 package bottom is thermally connected to the die for improved heat transfer out of the package. The exposed pad must be attached to a heat–sinking conduit. The pad is electrically connected to V_{EE} .

Table 2. ATTRIBUTES

Cha	Value					
Internal Input Pulldown Res	N/A					
Internal Input Pullup Resist	or	Ν	/A			
ESD Protection	> 2 kV > 150 V > 2 kV					
Moisture Sensitivity, Indefin	ite Time Out of Drypack	Pb Pkg	Pb-Free Pkg			
	LQFP-32 QFN-32	Level 2 N/A	Level 2 Level 1			
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in				
Transistor Count	596 Devices					
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test						

Table 3. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Power Supply	V _{EE} = 0 V		5	V
VI	Input Voltage	V _{EE} = 0 V	$V_{I} \leq V_{CC}$	5 to 0	V
l _{out}	Output Current	Continuous Surge		50 100	mA mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	32 LQFP 32 LQFP	80 55	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	Standard Board	32 LQFP	12 to 17	°C/W
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	QFN-32 QFN-32	31 27	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	2S2P	QFN-32	12	°C/W
T _{sol}	Wave Solder Pb Pb-Free			265 265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 4. TTL INPUT DC CHARACTERISTICS V_{CC} = 3.3 V, GND= 0.0 V, T_A = -40°C to 85°C

Symbol	Characteristic	Condition	Min	Тур	Мах	Unit
I _{IH}	Input HIGH Current	V _{IN} = 2.7 V			25	μA
I _{IHH}	Input HIGH Current MAX	V _{IN} = V _{CC}			100	μA
IIL	Input LOW Current	V _{IN} = 0.5 V			-0.6	mA
V _{IK}	Input Clamp Voltage	I _{IN} = –18 mA	-1.2	-0.9		V
V _{IH}	Input HIGH Voltage		2.0			V
V _{IL}	Input LOW Voltage				0.8	V

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Symbol	Characteristic	Condition		Тур	Max	Unit
I _{IH}	Input HIGH Current	V _{IN} = 2420 mV			150	μA
IIL	Input LOW Current	V _{IN} = 1490 mV			200	μΑ
V _{IH}	Input HIGH Voltage		2075		2420	mV
V _{IL}	Input LOW Voltage		1490		1675	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

Table 6. PECL OUTPUT DC CHARACTERISTICS V_{CC} = 3.3 V, GND = 0.0 V (Note 1)

			-40°C		25°C		85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current	85	115	145	90	120	155	95	130	155	mA
V _{OH}	Output High Voltage (Note 2)	2155	2280	2405	2155	2280	2405	2155	2280	2405	mV
V _{OL}	Output Low Voltage (Note 2)	1355	1520	1700	1355	1520	1700	1355	1520	1700	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

1. Input and output parameters vary 1:1 with V_{CC} .

2. All loading with 50 Ω to V_CC-2.0 V.

Table 7. AC CHARACTERISTICS $V_{CC} = 3.0 \text{ V to } 3.8 \text{ V}$ (Note 3)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f _{max}	Maximum Frequency (See Figure 4)	1.0	1.5		1.0	1.5		1.0	1.5		GHz
t _{PLH} , t _{PHL}	Propagation Delay to Output (Figure 5, Note 4) D to Q ENPECL to Q ENTTL to Q		450 500 450	800 875 800	100 150 300	500 500 500	875 875 800	100 200 300	500 550 500	800 925 800	ps
t _{JITTER}	Random Clock Jitter (RMS) (See Figure 4)		0.7	3.0		0.7	3.0		0.7	3.0	ps
t _r / t _f	Output Rise/Fall Times (20% – 80%)	100	200	450	100	200	250	100	200	300	ps
T _{SKEW}	Duty Cycle Skew (Note 5) D to Q Channel 0–7 Channel 8–9 ENPECL to Q ENTTL to Q		120 200 120 100	375 775 400 275		120 200 120 100	375 775 400 275		120 200 120 100	375 775 400 275	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

3. Measured using a 2.4 V source, 50% duty cycle clock source. All loading with 50 Ω to V_{CC}-2.0 V.

4. 1.5 V to 50% point of the output.

5. Duty cycle skew |t_{PLH} - t_{PHL}| on the specific path.





ORDERING INFORMATION

Device	Package	Shipping [†]
MC100EPT622FA	LQFP-32	250 Units / Tray
MC100EPT622FAG	LQFP-32 (Pb-Free)	250 Units / Tray
MC100EPT622FAR2G	LQFP-32 (Pb-Free)	2000 / Tape & Reel
MC100EPT622MNG	QFN32 (Pb-Free)	74 Units / Rail
MC100EPT622MNR4G	QFN32 (Pb-Free)	1000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Resource Reference of Application Notes

AN1405/D	-	ECL Clock Distribution Techniques
AN1406/D	-	Designing with PECL (ECL at +5.0 V)
AN1503/D	-	ECLinPS [™] I/O SPiCE Modeling Kit
AN1504/D	-	Metastability and the ECLinPS Family
AN1568/D	-	Interfacing Between LVDS and ECL
AN1672/D	-	The ECL Translator Guide
AND8001/D	-	Odd Number Counters Design
AND8002/D	-	Marking and Date Codes
AND8020/D	-	Termination of ECL Logic Devices
AND8066/D	-	Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

PACKAGE DIMENSIONS



PACKAGE DIMENSIONS



- DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS. DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN
- 0.25 AND 0.30 MM TERMINAL COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

FAD	AS WE	LL AS I		WIINA
	MIL			
DIM	MIN	NOM	MAX	
Α	0.800	0.900	1.000	
A1	0.000	0.025	0.050	
A3	0.	200 REI	F	
b	0.180	0.250	0.300	
D	5.			
D2	2.950	3.100	3.250	
Е	5			

0.500 BS



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